53rd INTERNATIONAL CONFERENCE ON MICROELECTRONICS, DEVICES AND MATERIALS

and the WORKSHOP on MATERIALS for ENERGY CONVERSION and THEIR APPLICATIONS: ELECTROCALORICS and THERMOELECTRICS



CONFERENCE 2017

CONFERENCE PROGRAM

October 4th - October 6th, 2017 Ljubljana, SLOVENIA

CONFERENCE MIDEM 2017 with Workshop on MATERIALS for ENERGY CONVERSION and THEIR APPLICATIONS: ELECTROCALORICS and THERMOELECTRICS

SHORT PROGRAMME, Ljubljana

October 4 - October 6, 2017

	Wednesday 4.10.	Thursday 5.10.	Friday 6.10.
7:00 - 7:15			
7:15 - 7:30		Workshop	
7:30 - 7:45		Chairs: B. Malič and S. Bernik	
7:45 - 8:00			
8:00 - 8:15			
8:15 - 8:30	REGISTRATION	REGISTRATION	REGISTRATION
8:30 - 8:45	neoiomation	REGISTRATION	REGISTRATION
8:45 - 9:00	OPENING CEREMONY	OPENING CEREMONY	
9:00 - 9:15		OPENING CEREMONT	
9:00 - 9:15	Optoelectronics	Invited Workshop:	Thin and Thick Films
	Invited	Xavier Moya	Chairman: S. Bernik
9:15 - 9:30	V. Sverdlov		
9:30 - 9:45	Chairman: M. Topič	Invited Workshop:	Sensors and MEMS
9:45 - 10:00		Brahim Dkhil	Chairman: D. Vrtačnik
10:00 - 10:15	0-1111	Statilit Stati	Original Di Vitacini
10:15 - 10:30	Optoelectronics I	to the date date of	
	Chairman: M. Topič	Invited Workshop:	COFFEE BREAK
10:30 - 10:45		Sylvia Gebhardt	
10:45 - 11:00			
11:00 - 11:15	COFFEE BREAK	COFFEE BREAK	
11.00 - 11.15	Materials, Technology		
11:15 - 11:30	and Devices		ELECTRONICS
11:15 - 11:30	Invited	Invited Workshop:	Chairman: A. Žemva
		Andrej Kitanovski	
11:30 - 11:45	E. Hennig		
11.50 - 11.45	Chair: B. Malič		
11:45 - 12:00	Markaniala Tankaniana		CLOSING CEREMONY
	Materials, Technology		
12:00 - 12:15	and Devices I	Workshop regular papers I	
12:15 - 12:30	Chair: B. Malič		
12:30 - 12:45			
12:45 - 13:00			
13:00 - 13:15			
13:15 - 13:30			
13:30 - 13:45	LUNCH	LUNCH	
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13:45 - 14:00			
14:00 - 14:15			
14:15 - 14:30			
14:30 - 14:45			
	Materials, Technology		
	and Devices II		
14:45 - 15:00	Chair: B. Malič	Workshop regular papers II	
15:00 - 15:15			
15:15 - 15:30			
	Integrated Circuits and		
15:30 - 15:45	System On Chip	Invited Workshop:	
15:45 - 16:00	Chairman: A. Sešek	Yuri Grin	
16:00 - 16:15			
16:15 - 16:30	COFFEE BREAK	COFFEE BREAK	
10:15 - 10:30			
16:20 16:45		Invited Workshop:	
16:30 - 16:45		Dario Narducci	
16:45 - 17:00 17:00 - 17:15	Ontantant to the	Darro Marqueer	
	Optoelectronics II		
17:15 - 17:30	Chairman: M. Topič	Invited Workshop:	
I I		Emmanuel Guilmeau	
17:30 - 17:45			
17:45 - 18:00			
18:00 - 18:15			
18:15 - 18:30			
18:30 - 18:45	WELCOME DARES		
18:45 - 19:00	WELCOME PARTY		
19:00 -		CONFERENCE DINNER	

ORGANIZER

MIDEM - Society for Microelectronics, Electronic Components and Materials, Stegne 7, 1000 Ljubljana, SLOVENIA

CONFERENCE SPONSORS

Jožef Stefan Institute, Ljubljana

Faculty for Electrical Engineering, University of Ljubljana

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IMAPS, Slovenia Chapter

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Polona Šorli, MIDEM, Slovenia Olga Zakrajšek, MIDEM, Slovenia Iztok Šorli, MIKROIKS d.o.o., Slovenia Tamara Matevc, Jožef Stefan Institute, Slovenia

GENERAL INFORMATION

Welcome to the 53rd International Conference on Microelectronics, Devices and Materials, (MIDEM 2017) and the joint Workshop on Materials for Energy Conversion and their Applications: Electrocalorics and Thermoelectrics. The conference continues the tradition of annual, international meetings organized by MIDEM – Society for Microelectronics, Devices and Materials, Ljubljana, Slovenia. These conferences have always attracted a large number of Slovene and foreign experts, as well as distinguished guest speakers, giving the opportunity to present their activities and research progress to the international audience and to discuss trends and problems related to their fields of work with other colleagues. This year, 37 reviewed regular papers and nine invited papers will be presented over the three days in the period October 4 – 6, 2017.

The regular conference contributions presented on the first and third day are grouped into five sessions: Materials, Technology and Devices; Electronics; Optoelectronics; Thin and Thick Films; Integrated Circuits and System on Chip. On the second day, the work will be organised as the Workshop on Materials for Energy Conversion and their Applications: Electrocalorics and Thermoelectrics.

We would like to express our thanks to the invited speakers and the contributors of regular papers for their valuable scientific contributions to the conference sessions and to the workshop. The members of the International Scientific Board of the conference, who made the review of the contributions, are gratefully acknowledged. We also thank all the Session Chairs and the members of the Conference Organizing Committee, who did their best to make the conference a success. Our special thanks go to the Jožef Stefan Institute as host to the conference.

We hope that you will remember this event, not only for the importance of the papers and discussions, but also for the new friendships and the pleasant memories of the country.

We wish you a pleasant stay in Ljubljana and in Slovenia.

Slavko Bernik, Chairman of the Conference MIDEM 2017 and Barbara Malič, Chair-person of the Workshop

Ljubljana, October 2017

CONFERENCE VENUE

The Conference is held from October 4th to October 6th, 2017 at Jožef Stefan Institute in Ljubljana, Slovenia.

CONFERENCE PROCEEDINGS

Invited and accepted papers are published in the Conference Proceedings distributed at the Conference registration.

LANGUAGE

The official Conference language is English.

REGISTRATION

The registration fees are as follows:

FULL registration fee: 300 EUR

MIDEM Society members, MIDEM Sponsors: 244 EUR

The fee includes Conference Proceedings and free access to all Conference events (Welcome party and Gala dinner).

Accompanying persons may join Welcome party at an extra charge of 40 EUR and Gala dinner at 60 EUR. Price for additional conference materials is 50 EUR.

Undergraduate students have free access to all Conference sessions on submitting their student card / index. For other Conference events, there will be an additional charge.

SOCIAL EVENTS

The Welcome party will be held on Wednesday, October 4th in the Gallery of Jožef Stefan Institute.

The gala dinner will be held on Thursday, October 5^{th} at 19:00 at Grad Kodeljevo.

ACCOMMODATION

Accommodation is available in:

City Hotel, Dalmatinova 15, Ljubljana – Slovenija

https://www.cityhotel.si/

Hotel Mrak, Rimska cesta 4, Ljubljana - Slovenija

Web: http://www.hotelmrak.si/

Programme and Organizing Committee, MIDEM 2017 Conference

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Conference Web page: http://www.midem-drustvo.si/conf2017

CONFERENCE PROGRAM

- 08:00 REGISTRATION
- 08:45 WELCOME AND OPENING CEREMONY
- 09:00 CONFERENCE PLENARY TALK CHAIRPERSON: M. Topič
- **V. Sverdlov, J. Weinbub and S. Selberherr**Spintronics as a Non-volatile Complement to Nanoelectronics
- 09:45 SESSION ON OPTOELECTRONICS CHAIRPERSON: M. Topič
- **O9:45** R. Kimovec, H. Helmers, A. W. Bett and M. Topič
 Power Loss Mechanisms in Monolithic-interconnected Six-segment
 Laser Power Converter
- 10:00 M. Markočič, M. Kovačič Modelling and Evaluation of Small OLEDs for Light Outcoupling Research
- 10:15 Š. Tomšič, K. Brecl, B. Lipovšek Optimisation of a SiNx Antireflective Coating in Crystalline Silicon Solar Cells by Considering Realistic Variable Illumination Conditions
- 10:30 G. Matič, M. Jankovec, M. Topič

 Development and Practical Evaluation of the Angular Response

 Measurement Setup for PV Cells
- 10:45 COFFEE BREAK
- 11:15 CONFERENCE INVITED TALK CHAIRPERSON: B. Malič
- 11:15 E. Hennig
 Structure Property Relations in BNT-BT Based Lead-free
 Piezoceramics

- 11:45 SESSION ON MATERIALS, TECHNOLOGY and DEVICES CHAIRPERSON: B. Malič
- 11:45 S. Bernik, M. Podlogar, S. Rustja, M. Cergolj
 Influence of Granulate and Pressure on the Green Compacts and
 Current-voltage Characteristics of Sintered ZnO-based Varistor
 Ceramics
- 12:00 M. Podlogar, Š. Hajduk, D. Luković Golić, T. Radošević, G. Branković, A. Rečnik, S. Bernik Growth of ZnO Films From Seed-grains With Different Morphologies
- 12:15 S. Tominc, S. Bernik, A. Rečnik, N. Daneu
 Microstructural and Current-voltage Characteristics of SnO₂-based
 Varistor Ceramics
- 12:30 M. Linec, J. Erjavec, B. Mušič
 Effect of Fillers With Different Coupling Agents on Mechanical Properties of Molded Composites
- 12:45 LUNCH
- 14:30 SESSION ON MATERIALS, TECHNOLOGY and DEVICES CHAIRPERSON: B. Malič
- 14:30 R. Šinkovec, B. Mušič

 The Effect of Different Lubricants on Molding Process and End Properties of Molded Composites
- 14:45 A.Šahinović, B. Mušič
 Differences Between Thermoset and Thermoplastic Based Strontium
 Ferrite Composites for Injection Molding
- **15:00 R. Zaplotnik** Atmospheric Pressure Plasma in Dentistry
- 15:15 SESSION ON INTEGRATED CIRCUITS and SYSTEM on CHIP CHAIRPERSON: A. Sešek
- 15:15 R. Ražman, T. Pleteršek, J. Trontelj
 ASIC for Impedance Spectroscopy of Human Skin
- 15:30 M. Gradišek, J. Trontelj, D. Strle High Precision Adjustable Gain Stage

- 15:45 D. Berčan, A. Sešek, J. Trontelj
 Design of Operational Transconductance Amplifier with
 Temperature Compensation
- 16:00 COFFEE BREAK
- 16:30 SESSION ON OPTOELECTRONICS CHAIRPERSON: M. Topič
- 16:30 Ž. Lokar, J. Krč and M. Topič
 RCWA Simulation of Partial Hetero-junction Silicon Solar Cell
 Structures With Nano and Micro Textures
- V. Gradišnik, D. Gumbarević, D. Caputo, G. de Cesare,
 S. Kraljević Pavelić
 Detection of Photoresponse of Cell Culture Medium by a:Si:H
 Photodiode Under Blue Light Exposure
- 17:00 J. Balent, J. Krč, A. Čampa, F. Smole and M. Topič Electrical Simulations of Hetero-junction Silicon Solar Cells
- 17:15 J. A. Vásquez and M. Topič
 An Overall Data Analysis Methodology for PV Energy Systems
- 17:30 S. Mitterhofer, M. Jankovec, M. Topič
 A Setup for In-situ Measurements of Potential and UV Induced
 Degradation of PV Modules Inside a Climatic Chamber
- 17:45 M. Pirc, M. Topič
 Light Intensity and Homogeneity of a LED Based Portable UV Light
 Source for Medical Research
- 18:00 WELCOME PARTY at JOŽEF STEFAN INSTITUTE

THURSDAY, OCTOBER 5

- 08:00 REGISTRATION
- 08:45 OPENING CEREMONY WORKSHOP on MATERIALS for ENERGY CONVERSION and their APPLICATIONS: ELECTROCALORICS and THERMOELECTRICS
- 09:00 WORKSHOP INVITED PAPERS CHAIRPERSON: B. Malič
- 09:00 X. Moya, P. Lloveras, E. Stern-Taulats, M. Barrio, J.-Ll. Tamarit, S. Crossley, W. Li, V. Pomjakushin, A. Planes, Ll. Manosa and N. D. Mathur
 Multicaloric Ferroelectrics
- 09:35 B. Dkhil

 Materials Approach for Improving Caloric Responses Using Ferroelectrics
- 10:10 S. Gebhardt, C. Molin, A. Greiner, P. Neumeister, H. Neubert Development of Perovskite-type Ceramics and Multilayer Device Structures for Electrocaloric Applications
- 10:45 COFFEE BREAK
- 11:10 A. Kitanovski, U. Tomc, J. Tušek, U. Plaznik, A. Poredoš Methods for Enhanced and Fast Heat Transfer in Electrocalorics
- 11:45 WORKSHOP REGULAR PAPERS CHAIRPERSONS: S. Bernik and B. Malič
- 11:45 M. Vrabelj, R. Katiliūte, M. Ivanov, L. Fulanović, A. Bradeško, Z. Kutnjak, J. Banys, B. Malič
 Electrocaloric and Dielectric Properties of Mn-doped 0.9Pb(Mg_{1/3}Nb_{2/3})O₃-0.1PbTiO₃ Ceramics
- 12:00 L. Fulanović, J. Koruza, N. Novak, V. Bobnar and B. Malič Stability of the High Electrocaloric-effect in Relaxor Pb(Mg_{1/3}Nb_{2/3})O₃ Multilayer Elements Upon Electric Field Cycling

- 12:15 A.Bradeško, M. Vrabelj, L. Fulanović, M. Otoničar, Z. Kutnjak, B. Malič and T. Rojac
 Influence of Cyclic Electrical Loading on The Electrocaloric Effect in PMN-xPT
- 12:30 R. Faye, S. Hirose, T. Usui, H. Strozyk, S. Nicolau, E. Defay Electrocaloric Prototyping With Multilayer Capacitors '- Heat Exchange Issues
- 12:45 LUNCH
- 14:30 WORKSHOP REGULAR PAPERS
 CHAIRPERSONS: S. Bernik and B. Malič
- 14:30 U. Prah, M. Wencka, Z. Kutnjak, M. Vrabelj, S. Drnovšek, B. Malič, H. Uršič

 Multicaloric Effect in Polycrystalline Pb(Fe_{0.5}Nb_{0.5})O₃
- 14:45 B. Podmiljšak
 Is the Magnetic Heat Pump Coming?
- 15:00 B. Jančar, T. Sever, D. Vengust, G. Dražič, S. Bernik Bulk Thermoelectrics With Layered Crystal Structure
- 15:15 A. Ferrario, S. Boldrini, A. Miozzo, M. Fabrizio
 Modeling and Experimental Characterization of Thermoelectric
 Devices in Steady-state and Fast Pulsed Condition
- 15:30 WORKSHOP INVITED PAPERS CHAIRPERSONS: S. Bernik and B. Malič
- 15:30 Y. Grin
 Chemistry of Thermoelectric Materials
- 16:05 COFFEE BREAK
- 16:35 D. Narducci
 Empowering Communication by Powering Electronics.
 Thermoelectrics for Heat Microharvesting

17:10 E. Guilmeau, C. Bourges, V. Pavan Kumar, P. Lemoine, T. Barbier, B. Raveau, B. Malaman, V. Nassif
Towards High Thermoelectric Performances in Complex Sulphide Materials

19:00 GALA DINNER AT GRAD KODELJEVO

The bus will arrive at Jožef Stefan Institute at 18:30.

FRIDAY, OCTOBER 6

- 08:00 REGISTRATION
- 09:00 SESSION ON THIN and THICK FILMS CHAIRPERSON: S. Bernik
- **D. L. Sekulić, Z. Ž. Lazarević, Č. D. Jovalekić, N. Z. Romčević**Characterization of Yttrium Orthoferrite (YFeO₃) Nanoparticles as Humidity Sensor Materials at Room Temperature
- **09:15** H. Mercier, B. Malič, H. Uršič, D. Kuščer, F. Levassort Processing and Sintering of Sodium-potassium Niobate-based Thick Films
- 09:30 SESSION ON SENSORS and MEMS CHAIRPERSON: D. Vrtačnik
- **D. Belavič, A. Bradeško, K. Makarovič, M. Hodnik, H. Uršič**Fluidic Elements and Sensors in LTCC-based Ceramic Microsystems
- 09:45 B. Pečar, M. Možek and D. Vrtačnik
 Thermoplastic PDMS Polymer Covalent Bonding for Microfluidic Applications
- 10:00 F. Gregor, M. Meyya, G. P. Ram
 Atmospheric Plasma Printing of Metal for Thin Layer Deposition,
 Nanowire Synthesis, and to Electronic Circuit Printing
- 10:15 COFFEE BREAK
- 10:45 SESSION ON ELECTRONICS CHAIRPERSON: A. Žemva
- 10:45 T. Murovič, A. Trost
 Design and Verification of A Digital Signal Processor
- 11:00 D. Markič, A. Žemva
 Design and Implementation of Multi-functional Portable Charging
 Device

- 11:15 M. Hajdič, J. Podržaj
 Evaluation of Solder Joint Reliability in Power Module of Drive System for Microfluidic Applications
- 11:30 M. Možek, B. Pečar, U. Aljančič, D. Resnik and D. Vrtačnik Low-power Piezoelectric Micropump Driving Module

11:45 CLOSING CEREMONY